

BTA04 T/D/S/A BTB04 T/D/S/A

SENSITIVE GATE TRIACS

FEATURES

■ VERY LOW IGT = 10mA max

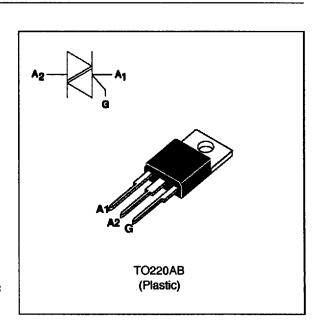
■ LOW I_H = 15mA max

■ BTA Family: INSULATING VOLTAGE = 2500V_(RMS) (UL RECOGNIZED: E81734)

DESCRIPTION

The BTA/BTB04 T/D/S/A triac family are high performance glass passivated PNPN devices.

These parts are suitables for general purpose applications where gate high sensitivity is required. Application on 4Q such as phase control and static switching.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit		
IT(RMS)	RMS on-state current	ВТА	Tc = 90°C	4	Α
	(360° conduction angle)	втв	Tc = 95°C		
ITSM	Non repetitive surge peak on-state current (Tj initial = 25°C)		tp = 8.3 ms	42	Α
			tp = 10 ms	40	
i2t	I ² t value	tp = 10 ms	8	A2s	
dl/dt	dt Critical rate of rise of on-state current Gate supply: IG = 50mA dig/dt = 0.1A/μs		Repetitive F = 50 Hz	10	A/µs
		Non Repetitive	50		
Tstg Tj	Storage and operating junction temperatu	- 40 to + 150 - 40 to + 110	ဗ္		
П	Maximum lead temperature for soldering during 10 s at 4.5 mm from case			260	°C

Symbol	Parameter	BTA / BTB04-				
		400 T/D/S/A	600 T/D/S/A	700 T/D/S/A		
VDRM VRRM	Repetitive peak off-state voltage Tj = 110°C	400	600	700	٧	

March 1995

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
Rth (j-a)	Junction to ambient	60	•c/w	
Rth (j-c) DC	Rith (j-c) DC Junction to case for DC BTA		4.4	•c/w
		ВТВ	3.2	7
Rth (j-c) AC	Junction to case for 360° conduction angle	ВТА	3.3	•c/w
	(F= 50 Hz)		2.4]

GATE CHARACTERISTICS (maximum values)

PG (AV) = 1W PGM = 40W (tp = 20 μ s) IGM = 4A (tp = 20 μ s) VGM = 16V (tp = 20 μ s).

ELECTRICAL CHARACTERISTICS

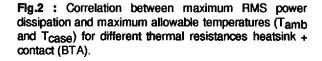
Symbol	Test Conditions		Quadrant	Quadrant		Suffix			
					Т	D	S	A	
lgт	V _D =12V (DC) R _L =33Ω	Tj=25°C	1-11-111	MAX	5	5	10	10	mA
			IV	MAX	5	10	10	25	
VGТ	V _D =12V (DC) R _L =33Ω	Tj=25°C	I-II-III-IV	MAX		1	.5		٧
VGD	VD=VDRM RL=3.3kΩ	Tj=110°C	I-II-III-IV	MIN	0.2			٧	
tgt	VD=VDRM IG = 40mA dIG/dt = 0.5A/μs	Tj=25°C	I-1I-III-IV	TYP	2		μs		
ŀL	IG= 1.2 IGT	Tj=25°C	I-{ I- V	TYP	10	10	20	20	mA
			11		20	20	40	40	
lн *	IT= 100mA gate open	Tj=25°C		MAX	15	15	25	25	mA
V _{TM} *	I _{TM} = 5.5A tp= 380µs	Tj=25°C		MAX	1.65		V		
DRM	V _{DRM} Rated	Tj=25°C		MAX	0.01			mA	
IRRM	IRRM VRRM Rated			MAX	0.75				
dV/dt *	Linear slope up to	Tj=110°C		TYP	10	10	-		V/µs
	V _D =67%V _{DRM} gate open			MIN	-	-	10	10	
(dV/dt)c *	(dl/dt)c = 1.8A/ms	Tj=110°C		TYP	1	1	5	5	V/µs

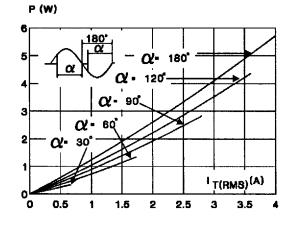
^{*} For either polarity of electrode A_2 voltage with reference to electrode A_1 .

ORDERING INFORMATION

Package	T(RMS)	VDRM / VRRM	Sensitivity Specification			
	A	V	Т	D	S	A
ВТА	4	400	X	x	Х	х
(Insulated)		600	Х	х	Х	х
		700	х	х	Х	х
ВТВ	7	400	Х	х	Х	х
(Uninsulated)		600	Х	х	Х	х
		700	Х	х	Х	х

Fig.1: Maximum RMS power dissipation versus RMS on-state current (F=50Hz). (Curves are cut off by (dl/dt)c limitation)

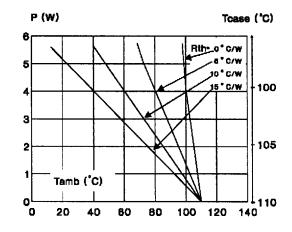


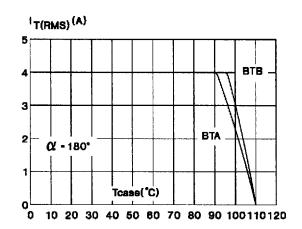


P (W) Tcase (°C) В Rth-_o c/w 10 ° C/W 95 16 ° C/W 100 3 106 Tamb (*C) 110 20 40 60 80 100 120 140 ۵

Fig.3: Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (BTB).

Fig.4: RMS on-state current versus case temperature.





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Fig.5: Relative variation of thermal impedance versus pulse duration.

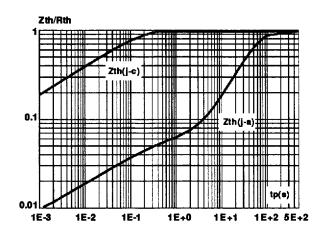


Fig.7: Non Repetitive surge peak on-state current versus number of cycles.

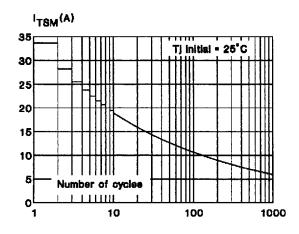


Fig.9: On-state characteristics (maximum values).

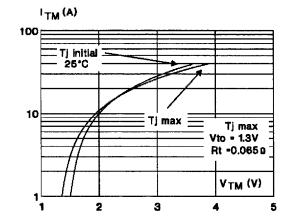


Fig.6: Relative variation of gate trigger current and holding current versus junction temperature.

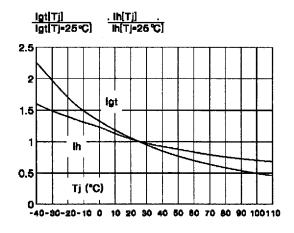
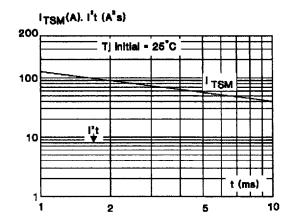


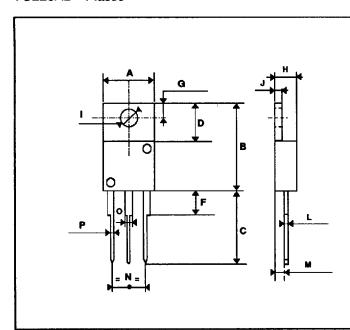
Fig.8 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \le 10$ ms, and corresponding value of I^2t .



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PACKAGE MECHANICAL DATA

TO220AB Plastic



REF.	DIMENSIONS					
	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
A	10.20	10.50	0.401	0.413		
В	14.23	15.87	0.560	0.625		
С	12.70	14.70	0.500	0.579		
D	5.85	6.85	0.230	0.270		
F		4.50		0.178		
G	2.54	3.00	0.100	0.119		
Н	4.48	4.82	0.176	0.190		
ı	3.55	4.00	0.140	0.158		
J	1.15	1.39	0.045	0.055		
L	0.35	0.65	0.013	0.026		
M	2.10	2.70	0.082	0.107		
N	4.58	5.58	0.18	0.22		
0	0.80	1.20	0.031	0.048		
P	0.64	0.96	0.025	0.038		

Cooling method: C Marking: type number Weight: 2.3 g

Recommended torque value : 0.8 m.N. Maximum torque value : 1 m.N.

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